# SOT-223 SCR

# Silicon Controlled Rectifiers Reverse Blocking Triode Thyristors

PNPN devices designed for line powered consumer applications such as relay and lamp drivers, small motor controls, gate drivers for larger thyristors, and sensing and detection circuits. Supplied in surface mount package for use in automated manufacturing.

- Sensitive Gate Trigger Current
- Blocking Voltage to 600 Volts
- · Glass Passivated Surface for Reliability and Uniformity
- Surface Mount Package
- Devices Supplied on 1 K Reel

# MCR08BT1 Series\*

\*Motorola preferred devices

SCR 0.8 AMPERE RMS 200 thru 600 Volts



CASE 318E-04 (SOT-223) STYLE 10

#### **MAXIMUM RATINGS** (T<sub>.J</sub> = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
Peak Repetitive Forward and Reverse Blocking Voltage <sup>(1)</sup> (1/2 Sine Wave, R <sub>GK</sub> = 1000 Ω, T <sub>J</sub> = 25 to 110°C)	VDRM, VRRM		Volts
MCR08BT1 MCR08DT1 MCR08MT1		200 400 600	
On-State Current RMS (T <sub>C</sub> = 80°C)	l <sub>T(RMS)</sub>	0.8	Amps
Peak Non-repetitive Surge Current (One Full Cycle, 60 Hz, T <sub>C</sub> = 25°C)	ITSM	10	Amps
Circuit Fusing Considerations (t = 8.3 ms)	l <sup>2</sup> t	0.4	A <sup>2</sup> s
Peak Gate Power, Forward, T <sub>A</sub> = 25°C	P <sub>GM</sub>	0.1	Watts
Average Gate Power (T <sub>C</sub> = 80°C, t = 8.3 ms)	P <sub>G(AV)</sub>	0.01	Watts
Operating Junction Temperature Range	TJ	-40 to +110	°C
Storage Temperature Range	T <sub>stg</sub>	-40 to +150	°C
Maximum Device Temperature for Soldering Purposes (for 10 Seconds Maximum	n) TL	260	°C

### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient PCB Mounted per Figure 1	$R_{ heta JA}$	156	°C/W
Thermal Resistance, Junction to Tab Measured on Anode Tab Adjacent to Epoxy	$R_{ heta JT}$	25	°C/W

<sup>1.</sup> V<sub>DRM</sub> and V<sub>RRM</sub> for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant source such that the voltage ratings of the devices are exceeded.

Preferred devices are Motorola recommended choices for future use and best overall value.

REV 1

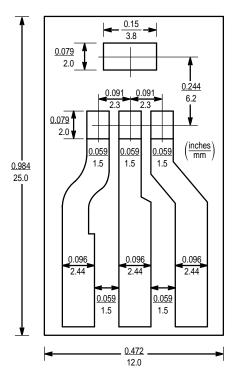


## **MCR08BT1 Series**

# **ELECTRICAL CHARACTERISTICS** (T<sub>C</sub> = $25^{\circ}$ C unless otherwise noted, R<sub>GK</sub> = 1 K $\Omega$ )

Characteristic	Symbol	Min	Тур	Max	Unit
Peak Repetitive Forward or Reverse Blocking Current $ (V_{AK} = \text{Rated V}_{DRM} \text{ or V}_{RRM},  R_{GK} = 1000  \Omega) \qquad \qquad T_{J} = 25^{\circ}\text{C} $ $ T_{J} = 110^{\circ}\text{C} $	IDRM, IRRM	_ _	_ _	10 200	μΑ μΑ
Maximum On-State Voltage (Either Direction)* (IT = 1.0 A Peak, TA = 25°C)	V <sub>TM</sub>	_	_	1.7	Volts
Gate Trigger Current (Continuous dc) (Anode Voltage = 7.0 Vdc, $R_L$ = 100 $\Omega$ )	IGT	_	_	200	μΑ
Holding Current (VD = 7.0 Vdc, Initializing Current = 20 mA, $R_{GK}$ = 1000 $\Omega$ )	lн	_	_	5.0	mA
Gate Trigger Voltage (Continuous dc) (Anode Voltage = 7.0 Vdc, $R_L$ = 100 $\Omega$ )	VGT	_	_	0.8	Volts
Critical Rate-of-Rise of Off State Voltage ( $V_{pk}$ = Rated $V_{DRM}$ , $T_C$ = 110°C, $R_{GK}$ = 1000 $\Omega$ , Exponential Method)	dv/dt	10	_	_	V/μs

<sup>\*</sup> Pulse Test: Pulse Width  $\leq$  300  $\mu$ s, Duty Cycle  $\leq$  2%.



BOARD MOUNTED VERTICALLY IN CINCH 8840 EDGE CONNECTOR. BOARD THICKNESS = 65 MIL., FOIL THICKNESS = 2.5 MIL. MATERIAL: G10 FIBERGLASS BASE EPOXY

Figure 1. PCB for Thermal Impedance and Power Testing of SOT-223

120°

0.4

0.5

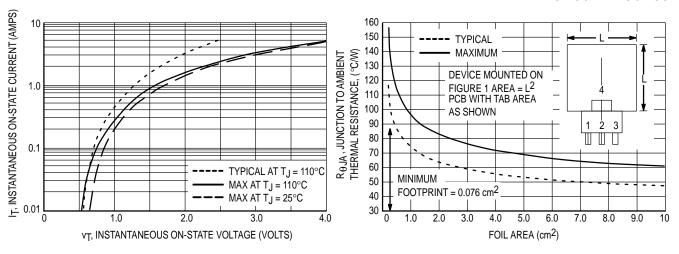


Figure 2. On-State Characteristics

Figure 3. Junction to Ambient Thermal Resistance versus Copper Tab Area

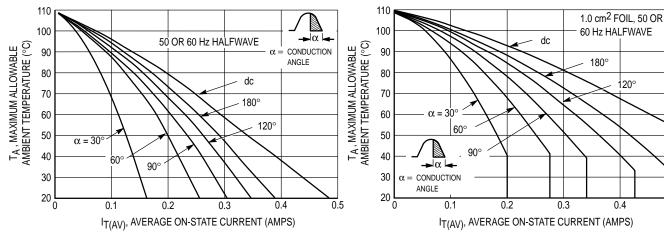


Figure 4. Current Derating, Minimum Pad Size **Reference: Ambient Temperature** 

Figure 5. Current Derating, 1.0 cm Square Pad **Reference: Ambient Temperature** 

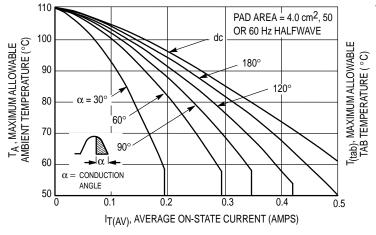


Figure 6. Current Derating, 2.0 cm Square Pad **Reference: Ambient Temperature** 

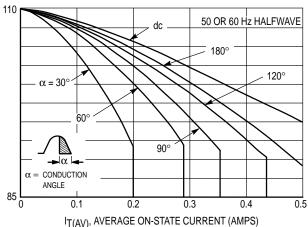


Figure 7. Current Derating Reference: Anode Tab

## **MCR08BT1 Series**

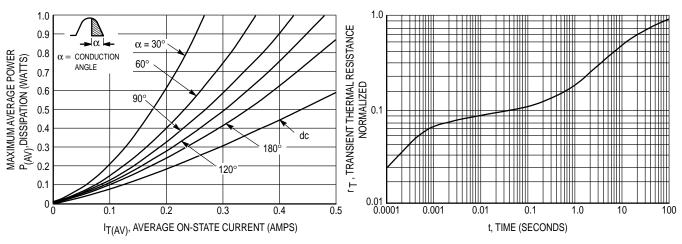


Figure 8. Power Dissipation

Figure 9. Thermal Response Device Mounted on Figure 1 Printed Circuit Board

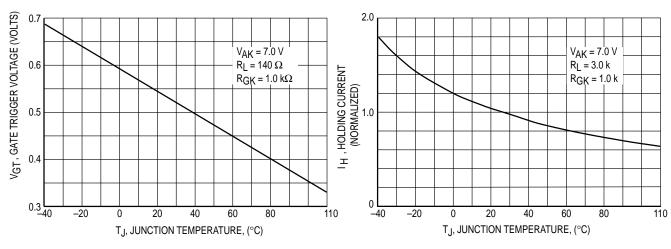


Figure 10. Typical Gate Trigger Voltage versus Junction Temperature

Figure 11. Typical Normalized Holding Current versus Junction Temperature

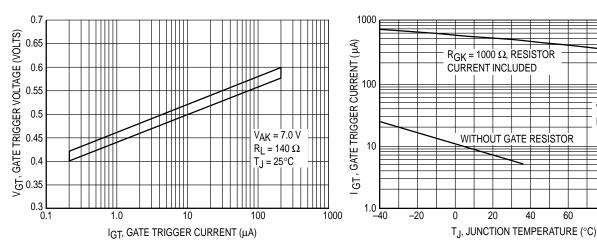


Figure 12. Typical Range of V<sub>GT</sub> versus Measured I<sub>GT</sub>

Figure 13. Typical Gate Trigger Current versus Junction Temperature

V<sub>AK</sub> = 7.0 V R<sub>L</sub> = 140 Ω

110

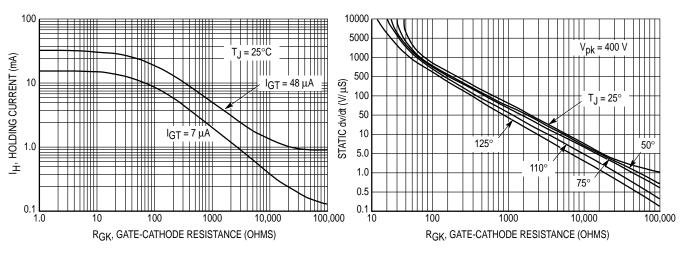


Figure 14. Holding Current Range versus Gate-Cathode Resistance

Figure 15. Exponential Static dv/dt versus Junction Temperature and Gate-Cathode Termination Resistance

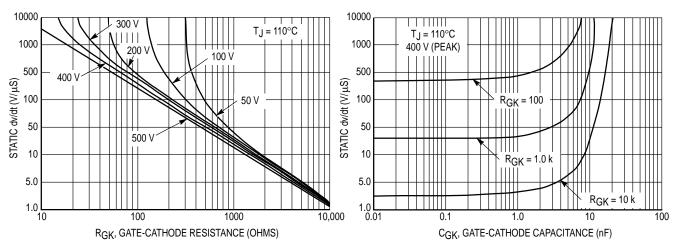


Figure 16. Exponential Static dv/dt versus Peak Voltage and Gate-Cathode Termination Resistance

Figure 17. Exponential Static dv/dt versus Gate-Cathode Capacitance and Resistance

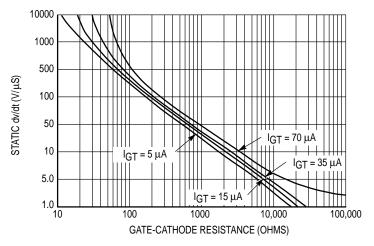
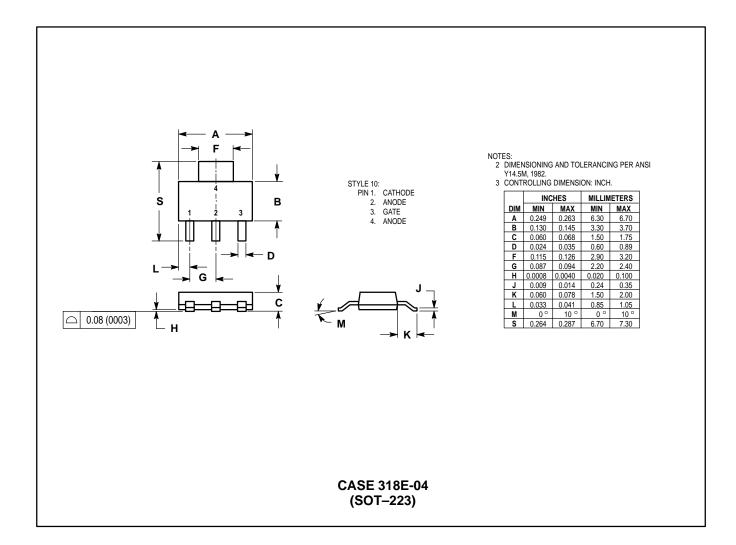


Figure 18. Exponential Static dv/dt versus Gate-Cathode Termination Resistance and Product Trigger Current Sensitivity

#### PACKAGE DIMENSIONS



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